| ABBOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® International and Pa | PC, Bannock  | burn, Illinois. A         | Il rights reserved untions. | under both           | This docume<br>level parts, t | ent is a declar<br>the declaration                              | ration of<br>n encom | the substance the substance passes all low | s within th<br>er level m       | e manufactu<br>aterials for w | rer listed it<br>which the m | em. Note<br>anufactu          | e: if the item is an a<br>rer has engineering | ssembly with low<br>responsibility. |  |
|--|--|---------------------------|-----------------------------|----------------------|-------------------------------|---|----------------------|--|---------------------------------|-------------------------------|------------------------------|-------------------------------|---|-------------------------------------|--|
|  | IPC Web Site for Information on IPC-1752 Standard Form Tyj<br>http://www.ipc.org/IPC-175x Distribute |                           |                             |                      | e *                           | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                      |  |                                 |                               | tials and Mfg Information    |                               |   |                                     |  |
| Supplier Information   |  |                           |                             |                      |                               |   |                      |  |                                 |                               |                              |                               |   |                                     |  |
| Company name*  | Company unique ID  |                           |                             | Unique ID Authority  |                               |   |                      |  | Response Date*                  |                               |                              |                               |   |                                     |  |
| onsemi   |  |                           |                             |                      |                               |   |                      |  |                                 |                               | 2024-04-25                   |                               |   |                                     |  |
| Contact Name Title - Contact   |  |                           |                             |                      |                               | Phone - Contact*  |                      |  |                                 | Email - Contact*              |                              |                               |   |                                     |  |
| Product-Env-Stewards   | Product Envi   | Product Enviro Compliance |                             |                      | NA                            |   |                      |  | Product-Env-Stewards@onsemi.com |                               |                              |                               |   |                                     |  |
| Authorized Representative* Title - Represent                           |  |                           | sentative P                 |                      |                               | Phone - Representative*   |                      |  |                                 | Email - Representative*       |                              |                               |   |                                     |  |
| Product-Env-Stewards   | Product Enviro Compliance  |                           |                             |                      | NA                            |   |                      |  | Product-Env-Stewards@onsemi.com |                               |                              |                               |   |                                     |  |
| Requester Item Number  | Requester Item Number Mfr Ite  |                           | m Number Mfr Item Name      |                      |                               | Effective Da  | ate Ve               | ersion                                     | Manufacturing Site              |                               | V                            | Veight*                       | UOM   | Unit Type                           |  |
|  | FSSD06   | FSSD06UMX 6-ch            |                             | 6-ch SDIO Switch     |                               | 2024-04-25 TH6  |                      | TH6  | H6                              |                               | 1.542                        | mg                            | Each  |                                     |  |
| Aanufacturing Proccess Informa   | tion   |                           |                             |                      |                               |   |                      |  |                                 |                               |                              |                               | 1   |                                     |  |
| Terminal Plating / Grid Array M  | aterial  | Ferminal Base             | Alloy                       | J-STD-020 MSL Rating |                               | Peak Process Body Tempera                                       |                      | ody Temperat                               | ture Max Time at Peak Tem       |                               | . Temperati                  | ature Number of Reflow Cycles |   |                                     |  |
| Precious metal (e.g. Ag,Au, NiPdAu) (no<br>Sn)                         |  | CU Alloy 1                |                             | 1                    |                               | 260   |                      | C  | 30                              |                               | second                       | ls 3                          |   |                                     |  |
| omments  |  |                           |                             |                      |                               |   |                      |  |                                 |                               |                              |                               |   |                                     |  |
| evel 1 - maximum time at peak temperat                                 | ure during so  | ldering is 10-3           | 0 seconds                   |                      |                               |   |                      |  |                                 |                               |                              |                               |   |                                     |  |
| or more information regarding materia                                  | composition  | please refer to           | page 3                      |                      |                               |   |                      |  |                                 |                               |                              |                               |   |                                     |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Iomogeneous Material Weight Unit of |       | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight | Unit of Measure |
|-------------------------------------|-------|-----------------|----------|--|-------------|--------|--------|-----------------|
| Die                                 | 0.379 | mg              | Supplier | Silicon (Si)   | 7440-21-3   |        | 0.379  | mg              |
| Die Attach                          | 0.033 | mg              | Supplier | Phenolic Resin-2   | 54208-63-8  |        | 0.01   | mg              |
|                                     |       |                 | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2  |        | 0.023  | mg              |
| Lead Frame                          | 2.86  | mg              | Supplier | Zinc (Zn)  | 7440-66-6   |        | 0.003  | mg              |
|                                     |       |                 | Supplier | Iron (Fe)  | 7439-89-6   |        | 0.066  | mg              |
|                                     |       |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 2.79   | mg              |
|                                     |       |                 | Supplier | Phosphorus (P)   | 7723-14-0   |        | 0.001  | mg              |
| Mold Compound-Black                 | 7.38  | mg              | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1 |        | 1.476  | mg              |
|                                     |       |                 | Supplier | Carbon Black (C)   | 1333-86-4   |        | 0.037  | mg              |
|                                     |       |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0  |        | 5.867  | mg              |
| Plating                             | 0.002 | mg              | Supplier | Palladium (Pd)   | 7440-05-3   |        | 0.0001 | mg              |
|                                     |       |                 | В        | Nickel (Ni)  | 7440-02-0   |        | 0.0018 | mg              |
|                                     |       |                 | Supplier | Gold (Au)  | 7440-57-5   |        | 0      | mg              |
| Wire Bond - Au                      | 0.888 | mg              | Supplier | Gold (Au)  | 7440-57-5   |        | 0.888  | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signar range of distribution unless otherwise noted)